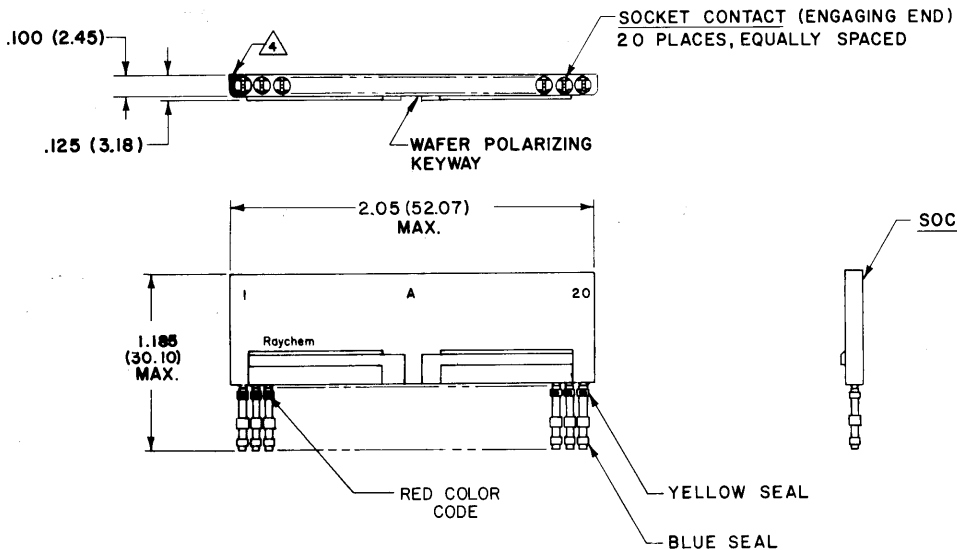


4

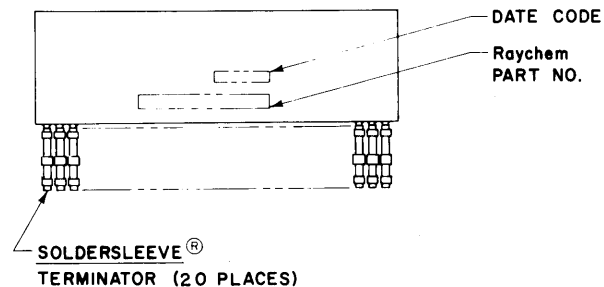
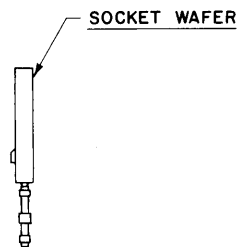
3

2

1



REVISIONS			
LTR	DESCRIPTION	DATE	APPROVED
A	REVISED PER ECN #T-17670	12 Aug 83	JB



⑤ WEIGHT (MAX.): LBS. | GRAMS
.0109 | 4.944

④ SOCKET NUMBER ONE IS MARKED IN CONTRASTING COLOR.

3. FINISH: 3-A SOCKET WAFER; FINISH TO BE AS MOLDED.
3-B SOCKET CONTACT; GOLD PLATE PER MIL-G-45204 CLASS 1.
(ENGAGING END)
3-C CONTACT TAIL; COATED WITH Sn63 SOLDER PER QQ-S-571
2. MATERIAL: 2-A SOCKET WAFER; HIGH GRADE POLYARYLENE THERMOPLASTIC.
2-B SOCKET CONTACT; COPPER ALLOY PER QQ-B-750.
2-C SOLDERSLEEVE® REFER TO RAYCHEM DWG. CTA-0068 FOR DATA.
TERMINATOR;

1. THIS WAFER ASSEMBLY USED IN MTC100 CONNECTORS.

If this document is printed it becomes uncontrolled.
Check with the web for latest revision.

NOTES:

SPECIFICATION CONTROL DRAWING

Raychem Corporation 1983

DRAWN	HAWKINGS	11-16 83	Raychem RAYCHEM CORPORATION 300 CONSTITUTION DRIVE MENLO PARK, CALIFORNIA 94025		
CHECKED	JB				
APPROVED	Plan	12-2-83	TITLE WAFER ASSEMBLY, SOCKET, "A" STYLE, 2", 20 CONTACTS, WITH OVAL ENTRY FOR 20-26 AWG. TEMP. RATING 125°C MTC100 SERIES		
APPROVED	Plan	12-2-87			
UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES ± .005 METRIC DIMENSIONS ARE IN PARENTHESES (MM)			SIZE	QDE IDENT NO	DWG NO
DO NOT SCALE THIS DRAWING			C	06090	MTC100-JA2-S14
			WEIGHT	⑤	SHEET 1 OF 1